ASSOCIATION CONNECTI ELECTRONICS INDUSTRI	Material Comp © Copyright 2005. international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						rials and M	ials and Mfg Information				
Supplier Inform	mation																
Company name* Compan				ompany unique ID U			Unique ID Authority					Respons	Response Date*				
onsemi													2025-05-13				
Contact Name			Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stew	vards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com						
Authorized Repres	sentative*	Title - Representative]	Phone - Representative*					Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com					
Reques	ster Item Number Mfr Item FDMC8		em Number Mfr Item Name C86320 FET 80V 11.7 Ohm N				Effective Da	Date Version		Manufacturing Site			Weigh	nt*	UOM	Unit Type	
					nm MLP33		2025-05-13]		РНМ		25.5362		mg	Each	
Janufacturing	g Proccess Informa	ation														·	
Termina	al Plating / Grid Array Material		Terminal Base Alloy J-		J-STD-020 M	D-020 MSL Rating		Peak Process Body Temperatur		ture M	ure Max Time at Peak Ten		ature Number of Reflow Cycles		eles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		C		30 seco		ds	3			
Comments																	
evel 1 - maximum	time at peak temperat	ure during so	ldering is 10-3	30 seconds													
or more informat	tion regarding materia	l composition	please refer t	o page 3													

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimuly and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.055	mg	Supplier	Silicon (Si)	7440-21-3		1.055	mg
Die Attach	0.1359	mg	Supplier	Silver (Ag)	7440-22-4		0.1155	mg
			Supplier	Acrylic resins	Proprietary Data		0.0204	mg
Lead Frame	13.2	mg	Supplier	Zinc (Zn)	7440-66-6		0.0158	mg
			Supplier	Iron (Fe)	7439-89-6		0.3102	mg
			Supplier	Copper (Cu)	7440-50-8		12.87	mg
			Supplier	Phosphorus (P)	7723-14-0		0.004	mg
Mold Compound-Black	10.3333	mg	Supplier	Silica Amorphous (SiO2)	7631-86-9		0.775	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0517	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8.215	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.5167	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.775	mg
Plating	0.259	mg	Supplier	Palladium (Pd)	7440-05-3		0.0185	mg
			В	Nickel (Ni)	7440-02-0		0.2375	mg
			Supplier	Gold (Au)	7440-57-5		0.0031	mg
Wire Bond	0.553	mg	Supplier	Palladium (Pd)	7440-05-3		0.0072	mg
			Supplier	Copper (Cu)	7440-50-8		0.5458	mg